

Features

- Ultra low leakage: nA level
- Ultra low operating voltage: 5V
- Ultra low clamping voltage
- Complies with following standards:
 - IEC 61000-4-2 (ESD) immunity test
 Air discharge: $\pm 25\text{kV}$
 Contact discharge: $\pm 15\text{kV}$
 - IEC61000-4-4 (EFT) 40A (5/50ns)
 - IEC61000-4-5 (Lightning) 25A (8/20 μs)
- RoHS Compliant

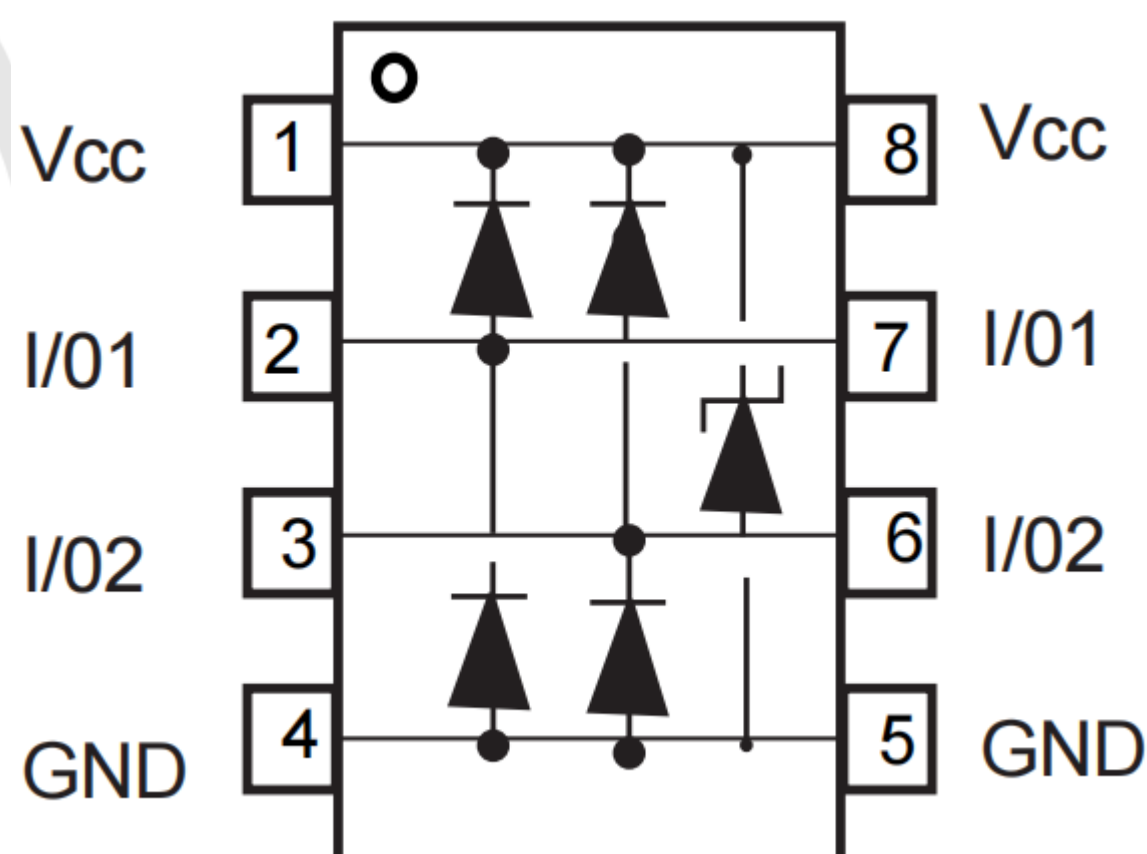
Mechanical Characteristics

- Package: SOP-8
- Lead Finish: NiPdAu
- Case Material: "Green" Molding Compound.
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminal Connections: See Diagram Below

Applications

- RS-423interfaces
- RS-485interfaces
- ISDNequipment
- T1/E1linecards
- HDSL/ASDLinterfaces

Dimensions and Pin Configuration



Absolute Maximum Ratings (Tamb=25°C unless otherwise specified)

TECH PUBLIC Parameter	Symbol	Value	Unit
Peak Pulse Power (8/20μs)	Ppk	450	W
Peak Pulse Current (8/20μs)	Ipp	25	A
ESD per IEC 61000-4-2 (Air)	VESD	±25	kV
ESD per IEC 61000-4-2 (Contact)		±15	
Operating Temperature Range	TJ	-55 to +125	°C
Storage Temperature Range	Tstg	-55 to +150	°C

Electrical Characteristics (TA=25°C unless otherwise specified)

Parameter	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Working Voltage	VRWM			5	V	
Reverse Breakdown Voltage	Vbr	6			V	IT=1mA
Reverse Leakage Current	IR			2	uA	VRWM = 5.25V
Clamping Voltage	VC			5.5	V	I _{PP} = 1A (8 x 20μs pulse), any I/O to GND
Clamping Voltage	VC			9.5	V	I _{PP} = 10A (8 x 20μs pulse), any I/O to GND
Clamping Voltage	VC			18	V	I _{PP} = 25A (8 x 20μs pulse), any I/O to GND
Junction Capacitance	CJ		3	5.0	pF	VR = 0V, f = 1MHz, any I/O to GND
Junction Capacitance	CJ		2.0		pF	VR = 0V, f = 1MHz, between I/O pins

Typical characteristics ($T_A=25\text{ }^{\circ}\text{C}$, unless otherwise noted)

Fig1. 8/20 μs Pulse Waveform

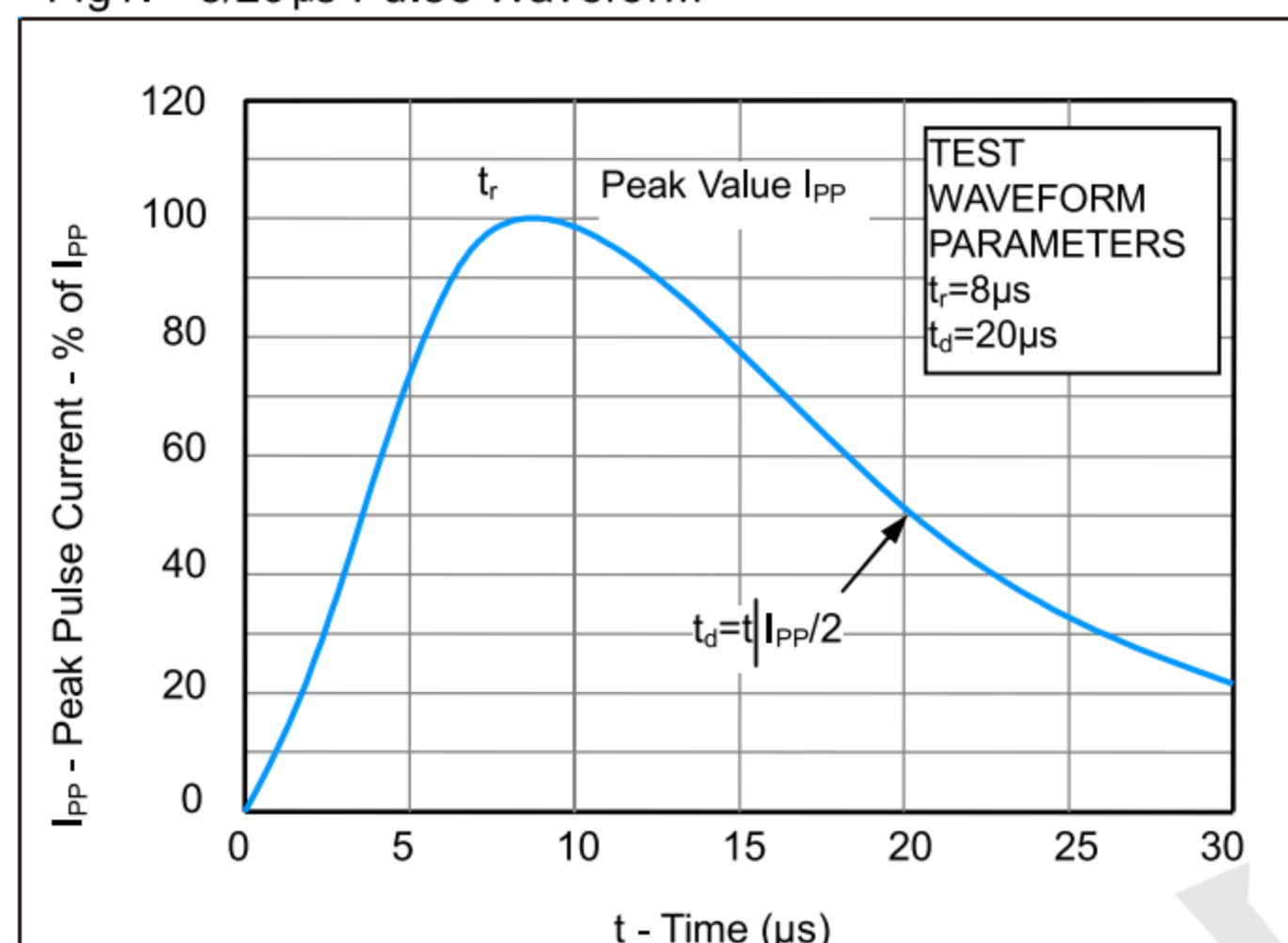


Fig2. ESD Pulse Waveform (according to IEC 61000-4-2)

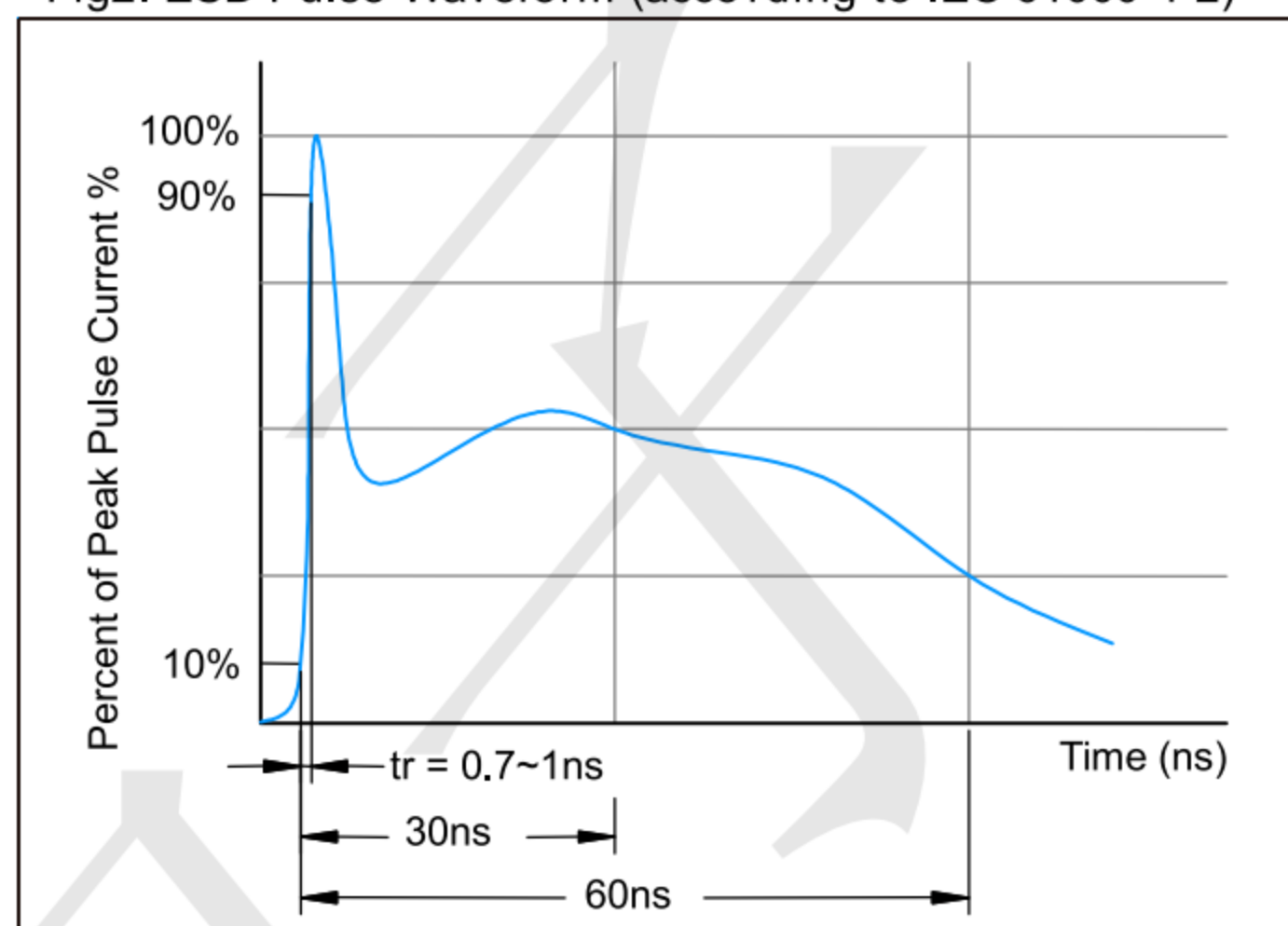
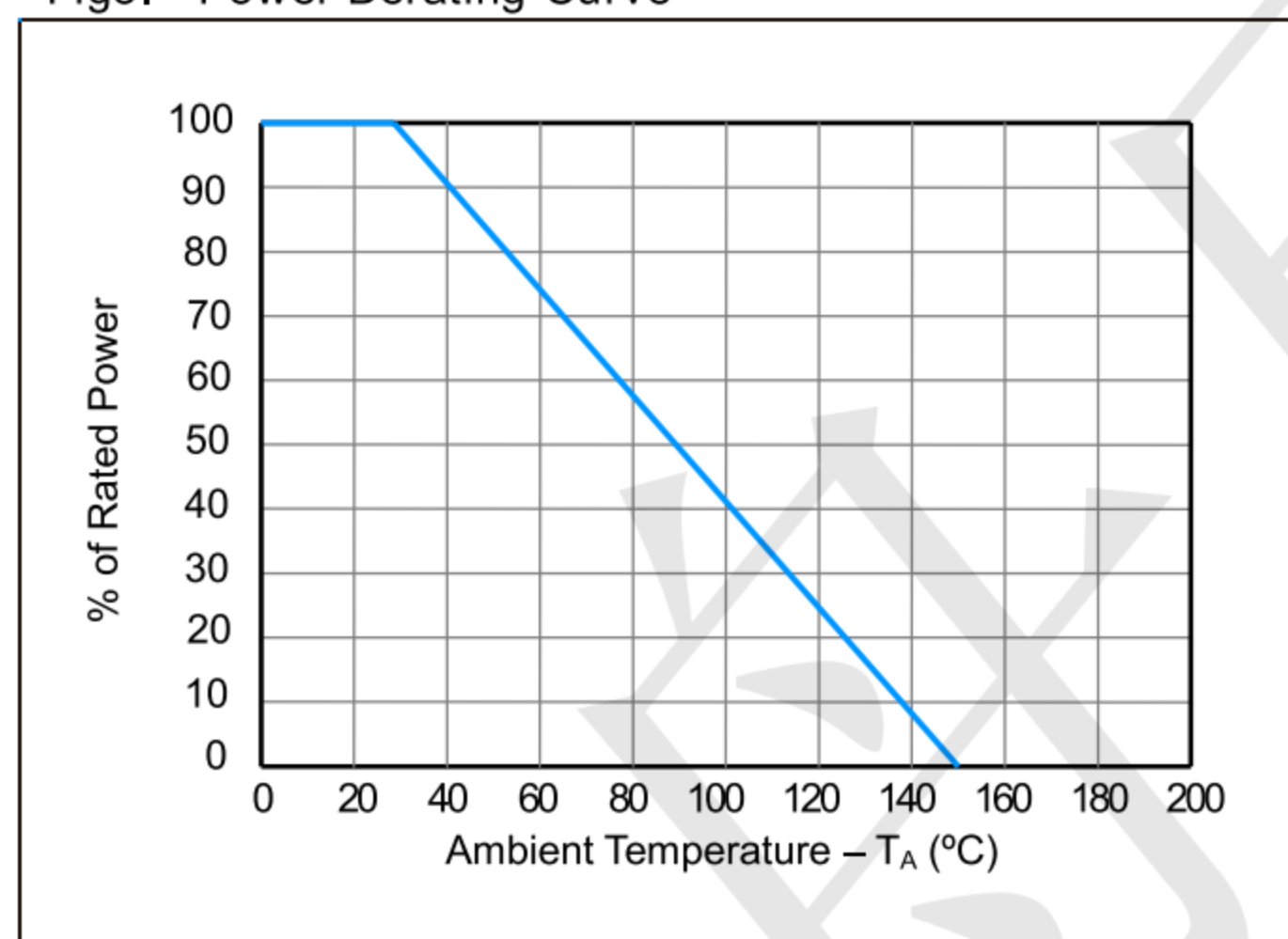
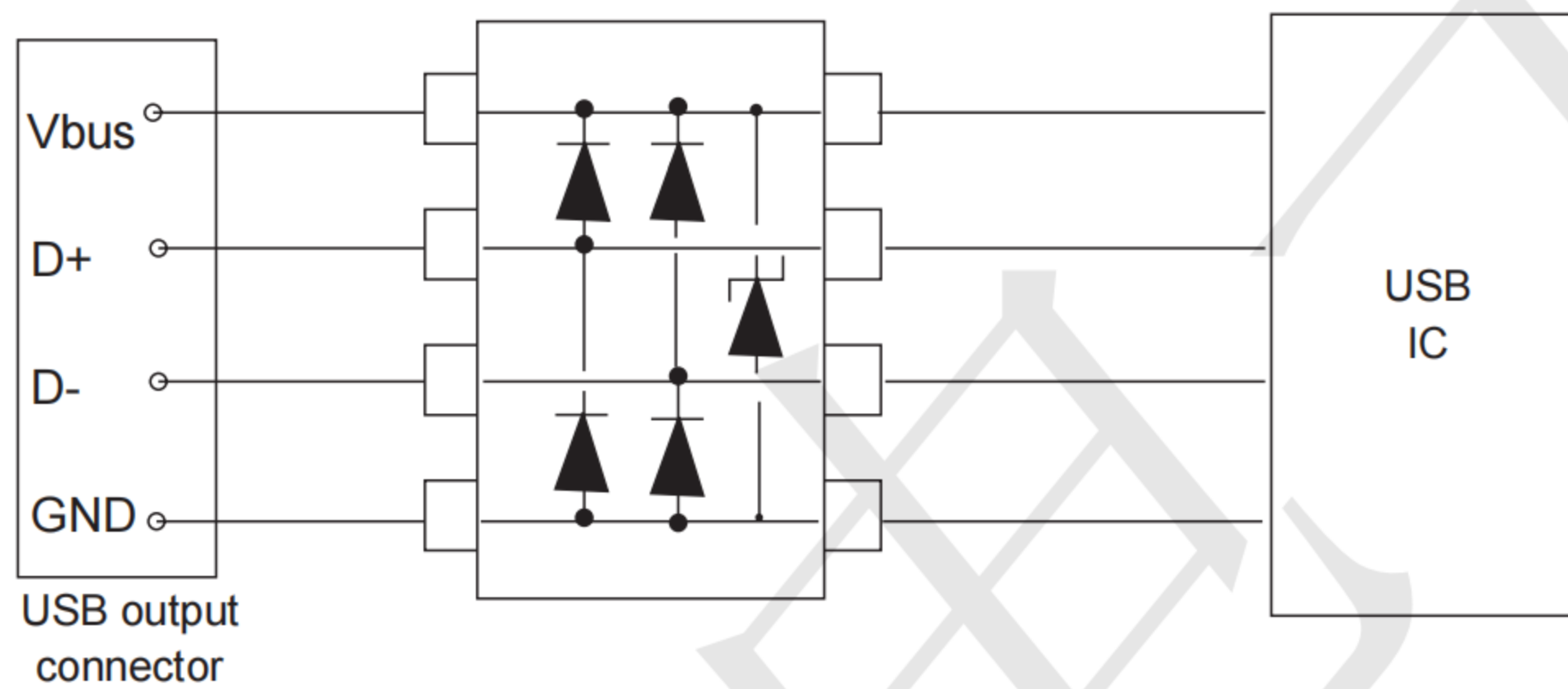


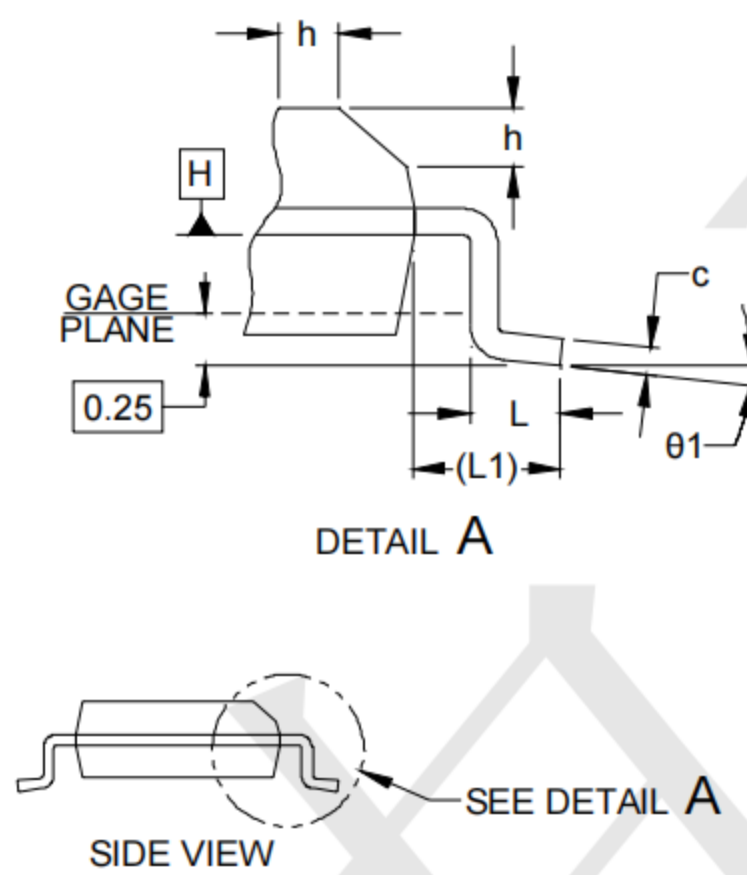
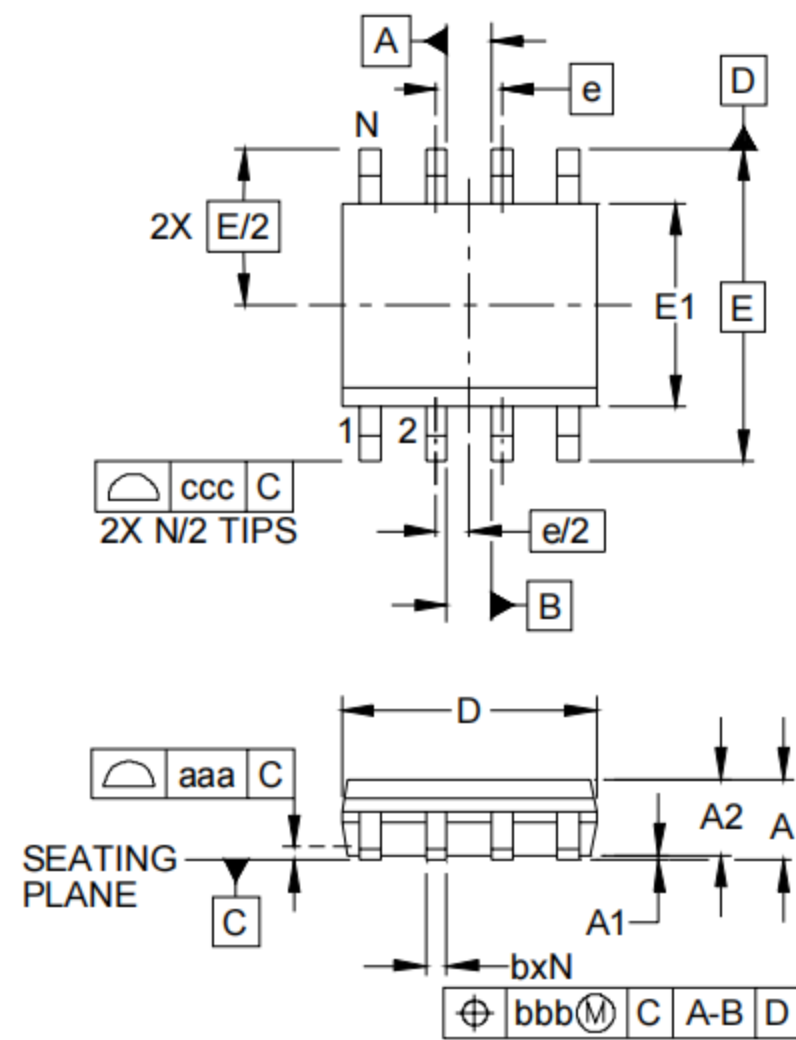
Fig3. Power Derating Curve



recommended configuration for USB port protection.



SOP-8 Package Outline Drawing



DIM	INCHES			MILLIMETERS		
	MIN	NOM	MAX	MIN	NOM	MAX
A	.053	-	.069	1.35	-	1.75
A1	.004	-	.010	0.10	-	0.25
A2	.049	-	.065	1.25	-	1.65
b	.012	-	.020	0.31	-	0.51
c	.007	-	.010	0.17	-	0.25
D	.189	.193	.197	4.80	4.90	5.00
E1	.150	.154	.157	3.80	3.90	4.00
E	.236 BSC			6.00 BSC		
e	.050 BSC			1.27 BSC		
h	.010	-	.020	0.25	-	0.50
L	.016	.028	.041	0.40	0.72	1.04
L1	(.041)			(1.04)		
N	8			8		
θ1	0°	-	8°	0°	-	8°
aaa	.004			0.10		
bbb	.010			0.25		
ccc	.008			0.20		

Suggested Land Pattern

